

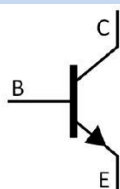
**/ Descriptions**

SOT-23          NPN

**/ Features**

**/ Applications**

**/ Equivalent Circuit**



**/ Pinning**

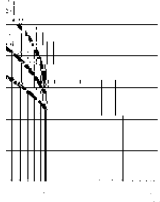
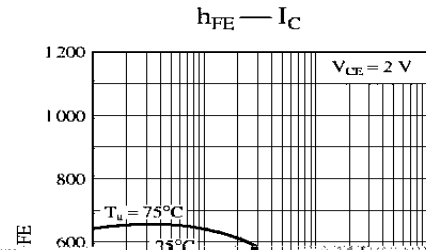
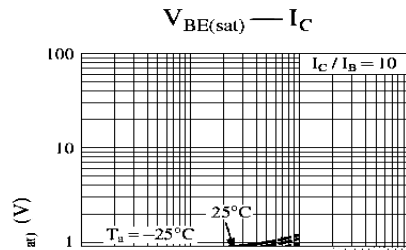
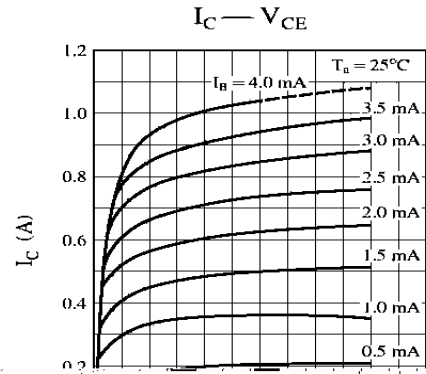
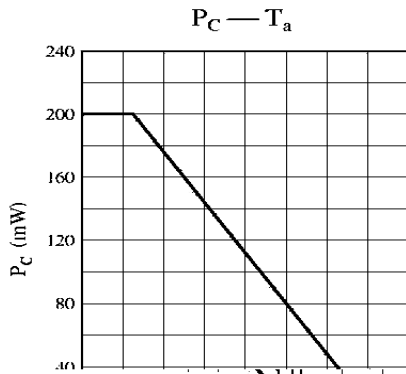


**/ h<sub>FE</sub> Classifications & Marking**

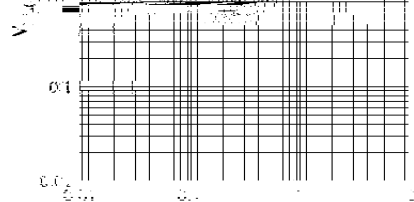
	~ 800

		~	

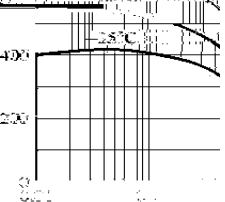
/ Electrical Characteristic Curve



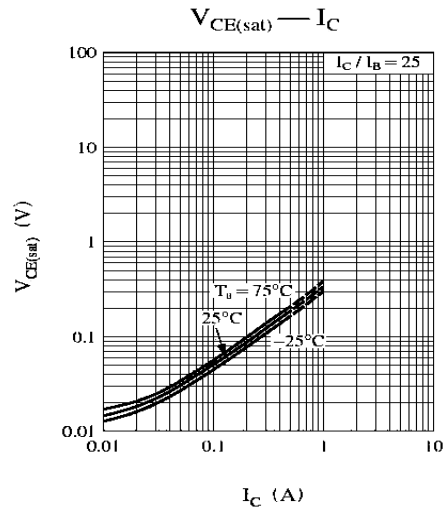
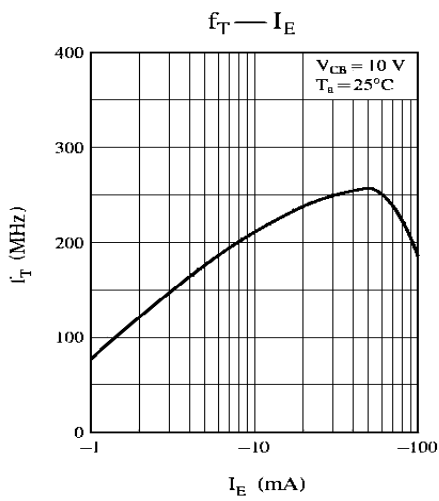
A)



$I_C$  (A)

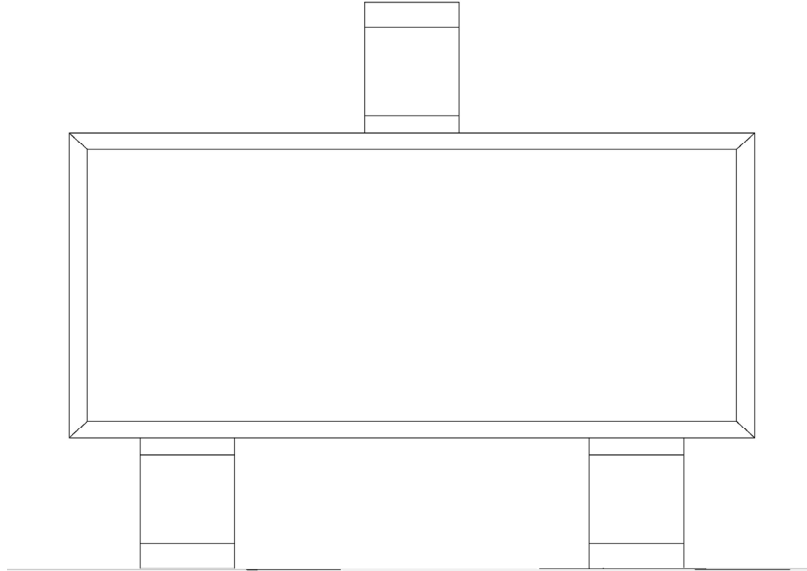


$I_C$  (A)





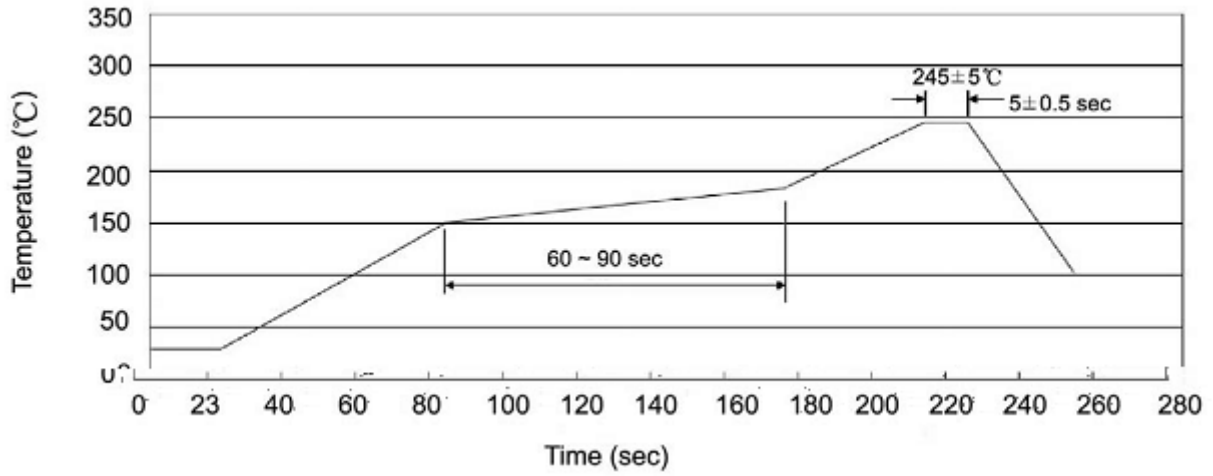
/ Marking Instructions



1D

H

( ) / Temperature Profile for IR Reflow Soldering(Pb-Free)



± ± ± ±

/ Resistance to Soldering Heat Test Conditions

± ±

/ Packaging SPEC.

封装形式	包装数量					包装尺寸 :		
	只卷盘	卷盘盒	只盒	盒箱	只箱		盒	箱
						"		

/ Notices